07-6-8-05

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

pplication of: Horowitz et al.

Confirmation No.: 7838

Application No.: 09/594,221

Group Art No.: 2631

Filed: June 14, 2000

Examiner: Phu, Phuong M.

For:

Method and Apparatus for

Attorney Docket No.: 60809-5055-US

Transmitting Data with Reduced

(formerly RB1-003US)

Express Mail No. EV 534 877 630 US

Coupling Noise

TRANSMITTAL OF REVOCATION AND POWER OF ATTORNEY

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Applicant's representative encloses herewith a Revocation and Power of Attorney for the application number listed above. Applicant's attorney requests that the Power of Attorney be accepted and made of record.

Future correspondence should be forwarded to:

Customer No. 38426

No fee is believed owed with this submission. The Commissioner is authorized to charge any fees associated with this communication to our deposit account number 50-0310 (order no. 60809-5055-US). A copy of this sheet is enclosed for such purpose.

Respectfully submitted,

Date July 6, 2005

Dion M. Bregman

Reg. No. 45,645

MORGAN, LEWIS & BOCKIUS LLP

2 Palo Alto Square

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(640) 843-4000

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:

See Schedule A

Serial No.:

See Schedule A

Filed:

See Schedule A

For:

See Schedule A

Attorney Docket No:

See Schedule A

REVOCATION AND POWER OF ATTORNEY

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

SIR:

Rambus, Inc. owner of the entire right, title and interest in, to and under the inventions listed in Schedule A hereby revokes all previous powers of attorney and appoints Morgan, Lewis & Bockius LLP, Customer No. 38426, and each of them, its attorneys, prosecute these matters, and to transact all business in the Patent and Trademark Office connected therewith, said appointment to be to the exclusion of the inventors and their attorney(s) in accordance with the provisions of 37 C.F.R. 3.71, provided that, if any one of these attorneys ceases being affiliated with the law firm of Morgan, Lewis & Bockius LLP as partner, counsel, or employee, then the appointment of that attorney and all powers derived therefrom shall terminate on the date such attorney ceases being so affiliated.

In addition, the undersigned assignee also appoints Kent R. Richardson (Reg. No. 39,443), Paul M. Anderson (Reg. No. 39,896), Paula J. Lagattuta (Reg. No. 40,691), Jose G. Moniz (Reg. 50,192) and Lance Kreisman (Reg. No. 39,256) of Rambus Inc., to prosecute these matters and to transact all business in the Patent and Trademark Office connected therewith.

Please direct all future correspondence to the address associated with Customer No. 38426, Morgan, Lewis & Bockius LLP and direct all telephone calls to Morgan, Lewis & Bockius LLP at (650) 843-4000.

Assignee:

Date:

6/30/05

Signature:

RICHARDSON VICE PRESIDENT INTELLECTUAL

Position/Title:

Typed Name:

Address:

4440 El Camino Real

Mountain View, California 94022

SCHEDULE A

Serial No./ Patent No.	Filing Date/ Issue Date	Title	First Named Inventor	Attorney Docket No.
09/468,247	12/20/1999	Chip Socket Assembly and Chip File Assembly for Semiconductor Chips (RA041.C1D1.US)	Donald V. Perino	60809-5051-US
6,352,435	03/05/2002			
09/957,815	09/20/2001	Chip Socket Assembly and Chip File Assembly for Semiconductor Chips (RA041.C1D1C1.US)	Donald V. Perino	60809-5052-US
6,619,973	09/16/2003			
09/957,822	09/20/2001	Chip Socket Assembly and Chip File Assembly for Semiconductor Chips (RA041.C1D1C2.US)	Donald V. Perino	60809-5053-US
6,589,059	07/08/2003			
09/961,114	09/20/2001	Chip Socket Assembly and Chip File Assembly for Semiconductor Chips (RA041.C1D1C3.US)	Donald V. Perino	60809-5054-US
09/594,221	06/14/2000	Method and Apparatus for Transmitting Data with Reduced Coupling Noise (RA163.P.US)	Mark A. Horowitz	60809-5055-US
11/130,502	05/17/2005	Method and Apparatus for Transmitting Data with Reduced Coupling Noise (RA163.CA.US)	Mark A. Horowitz	60809-5056-US
09/817,828	03/26/200	Clock Routing in Multiple Channel Modules and Bus	Ravindranath T. Kollipara	60809-5057-US
6,590,781	07/08/2003	Systems (RA171.CIP1.US)		
10/420,308	04/22/2003	Clock Routing in Multiple Channel Modules and Bus Systems (RA171.CIP1D1.US)	Ravindranath T. Kollipara	60809-5058-US
09/679,143	10/03/2000	Semiconductor Stacked Die Devices (RA189.P.US)	Belgacem Haba	60809-5060-US
6,674,161	01/06/2004			
10/706,897	11/13/2003	Methods of Forming Semiconductor Stacked Die Devices (RA189.D1.US)	Belgacem Haba	60809-5061-US
6,902,953	06/07/2005			
11/123,641	05/06/2005	Semiconductor Stacked Die Devices and Methods for Forming Semiconductor Stacked Die Devices (RA189.D1C1.US)	Belgacem Haba	60809-5062-US
10/438,238	05/14/2003	Multilayer Flip-Chip Substrate Interconnect Layout (RA291.P.US)	Hao Shi	60809-5063-US